KAMAYA OHM

No.: TWLC-K-HTS-0001 /4

Date: 2023. 1. 20

Data sheet

Title: FIXED CHIP RESISTORS; RECTANGULAR TYPE & WIDE

TERMINATION - LOW OHM

Style: TWLC32,50,63

RoHS COMPLIANCE ITEM Halogen and Antimony Free

Note: •Stock conditions

Temperature: $+5^{\circ}$ C $\sim +35^{\circ}$ C Relative humidity: $25\% \sim 75\%$

The period of guarantee: Within 2 year from shipmen t by the company.

Solderability shall be satisfied.

- Product specification contained in this data sheet are subject to change at any time without notice
- If you have any questions or a Purchasing Specification for any quality agreement is necessary, please contact our sales staff.



Hokkaido Research Center Approval by: T. Sannomiya Drawing by: M. Shibuya

No: TWLC-K-HTS-0001

Title: FIXED CHIP RESISTORS; RECTANGULAR TYPE & WIDE TERMINATION - LOW

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1. Scope

1.1 This data sheet covers the detail requirements for fixed chip resistors; rectangular type & wide termination - low ohm, style of TWLC32, 50, 63.

1.2 Applicable documents

JIS C 5201-1: 2011S C 5201-8: 2014, JIS C 5201-8-1: 2014 IEC60115-1: 2008, IEC60115-8: 2014, IEC60115-8-1: 2014 EIAJ RC-2134C-2010

2. Classification

Type designation shall be the following form.

(Example)

TWLC	50	-	R470	J	TE
1	2	3	4	5	6
Style					

1 Fixed thick film chip resistors; rectangular type and low ohm

— Style

2 Size

3 Temperature coefficient of resistance

-(Dash)	Standard

4 Rated resistance Rated resistance and symbol shall be in accordance with Sub-clause 3.3.

R470 4 digit, Ex. R470--> $470 \text{m}\Omega$,

5 Tolerance on rated resistance

F	±1%
J	±5%

6 Packaging form

99 .0	
В	Bulk (loose package)
TP	Paper taping
TE	Embossed taping

3. Rating

3.1 The ratings shall be in accordance with Table-1.

Table-1

Style	Rated dissipation (W)	Rated current range (A)	Temperature resistance		Rated resistance range(Ω)	Tolerance on rated resistance					
				0~+200	0.5~0.91						
TWLC32	1.0	1.04~3.16	-(Dash)	0~+250	0.2~0.47	F(±1%), J(±5%)					
									0~+350	0.1~0.18	
TWLC50	1.0	1.04~3.16	-(Dash)	0~+200	0.2~0.91	F(±1%), J(±5%)					
TVVLCSU	1.0	1.04~3.10	-(Dasii)	0~+350	0.1~0.18	F(±1%), J(±3%)					
TWLC63	2.0	1.48~4.47	-(Dash)	0~+200	0.2~0.91	E(+19/) I(+59/)					
TVVLCOS	2.0	1.40~4.47 –(D	1.40~4.47	-(DaSH)	0~+350	0.1~0.18	F(±1%), J(±5%)				

Style	Limiting element voltage(V)	Insulation voltage (V)	Category temperature range (°C)
TWLC32	0.95		
TWLC50	0.95	500	-55~+155
TWLC63	1.34		

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3.2 Rated resistance

The rated resistance shall be in accordance with Table-2

Table-2

Rated resistanc	е	Rated resistance	
Rated resistance [mΩ]	Symbol	Rated resistance [m Ω]	Symbol
100	R100	400	R400
110	R110	430	R430
120	R120	470	R470
130	R130	500	R500
150	R150	510	R510
160	R160	560	R560
180	R180	600	R600
200	R200	620	R620
220	R220	650	R650
240	R240	680	R680
250	R250	700	R700
270	R270	750	R750
300	R300	800	R800
330	R330	820	R820
360	R360	900	R900
390	R390	910	R910

3.3 Climatic category

55/155/56 Lower category temperature $-55 \,^{\circ}\text{C}$ Upper category temperature $+155 \,^{\circ}\text{C}$ Duration of the damp heat, steady state test 56days

3.4 Stability class

5% Limits for change of resistance:

-for long–term tests $\pm 5\%$ -for short–term tests $\pm 1\%$

3.5 Derating

The derated values of dissipation at temperature in excess of 70 °C shall be as indicated by the following curve.

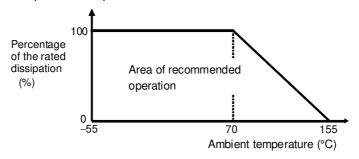


Figure-1 Derating curve

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3.6 Rated voltage

d.c. or a.c. r.m.s. voltage calculated from the square root of the product of the rated resistance and the rated dissipation.

$$E = \sqrt{P \cdot R}$$

E: Rated voltage (V)

P: Rated dissipation (W)

R: Rated resistance (Ω)

Limiting element voltage can only be applied to resistors when the resistance value is equal to or higher than the critical resistance value.

At high value of resistance, the rated voltage may not be applicable.

3.7 Rated current

The rated current calculated from the square root of the quotient of the rated resistance and the rated dissipation.

I: Rated current (A)

P: Rated dissipation (W)

R: Rated resistance (Ω)

The rated current shall be corresponding to rated voltage.

4. Packaging form

The standard packaging form shall be in accordance with Table-3.

Table-3

Symbol	Packaging form		Standard packaging quantity / units	Application
В	Bulk (loose package)		1,000 pcs.	TWLC32,50,63
TP	Paper taping	8mm width, 4mm pitches	5,000 pcs.	TWLC32
TE	Embossed taping	12mm width, 4mm pitches	4,000 pcs.	TWLC50,63

5. Dimensions

5.1 The resistor shall be of the design and physical dimensions in accordance with Figure-2 and Table-4.

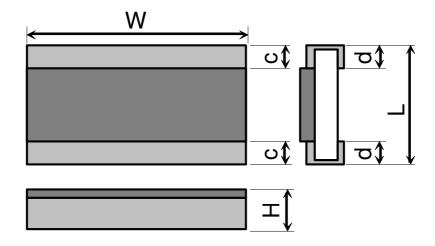


Figure-2

Table_4 Unit: mm

		10.010			•
Style	Ш	W	Н	С	d
TWLC32	1.6±0.2	3.2±0.2	0.55±0.10	0.5±0.25	0.5±0.25
TWLC50	2.5±0.15	5.0±0.2	0.55±0.10	0.6±0.2	0.6±0.2
TWLC63	3.2±0.2	6.3±0.2	0.6±0.1	0.6±0.2	0.6±0.2

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6. Marking

The rated resistance shall be marked in 4 characters consisting of 3 figures or 3 figures and a letter and marked on over coat

(Example) "R100" \rightarrow 0.1 [Ω]

7. Performance

- 7.1 The standard condition for tests shall be in accordance with Sub-clause 4.2, JIS C 5201–1: 2011.
- 7.2 The performance shall be satisfied in Table-5.

Table-5(1)

No.	Test items	Condition of test (JIS C 5201–1)	Performance requirements
1	Visual examination	Sub-clause 4.4.1 Checked by visual examination.	As in 4.4.1 The marking shall be legible, as
2	Dimension	Sub-clause 4.4.2	checked by visual examination. As specified in Table-4 of this
	Resistance	Sub-clause 4.5 Measurement current: 10(mA) Note: The measuring apparatus corresponding to Digital multimeter of TR6878 for Advantest Corp	specification. As in 4.5.2 The resistance value shall correspond with the rated resistance taking into account the specified tolerance.
3	Voltage proof	Sub-clause 4.7 Method: 4.6.1.4 Test voltage: Alternating voltage with a peak value of 1.42 times the insulation voltage. Duration: 60 s±5 s Insulation resistance Test voltage: Insulation voltage	No breakdown or flash over $R \geq 1 \; G\Omega$
4	Solderability	Duration: 1 min. Sub-clause 4.17 Without aging	As in 4.17.4.5 The terminations shall be covered with
		Flux: The resistors shall be immersed in a non–activated soldering flux for 2 s. Bath temperature: 245 °C±5 °C Immersion time: 2 s±0.5 s	a smooth and bright solder coating.
5	Mounting	Sub-clause 4.31 Substrate material: Epoxide woven glass	
	Overload (in the mounted state)	Sub-clause 4.13 The applied voltage shall be 2.5 times the rated voltage or the current corresponding to. Duration: 2 s Visual examination Resistance	No visible damage $\Delta R \le \pm 1\%$
	Solvent resistance of the marking	Sub-clause 4.30 Solvent: 2-propanol Solvent temperature: 23 °C±5 °C Method 1 Rubbing material: cotton wool Without recovery	Legible marking

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Table-5(2)

No	Test items	Condition of test (JIS C 5201-1)	Performance requirements
6	Mounting	Sub-clause 4.31 Substrate material: Epoxide woven glass	
	Bound strength of the end	Sub-clause 4.33	
	face plating Final measurements	Bent value: TWLC32: 3mm TWLC50,63: 1 mm	ΔR ≤ ±1%
	Final measurements	Resistance	No visible damage
		Sub-clause 4.33.6 Visual examination	TNO VISIDIE dai nage
7	Resistance to soldering heat	Sub-clause 4.18 (JEITA RC-2144 2.3.2)	
'	riesistance to soldening rieat	T ₁ :Pre-heat minimum temp.:150±5 °C	
		T ₂ :Pre-heat maximum temp.:180±5 °C	
		T ₃ :Soldering temp.:220 °C	
		T ₄ :Peak temp.:250 °C	
		t ₁ :Pre-heat duration:120±5 s	
		t₂:Soldering duration:60 to 90 s	
		t₃:Peak duration(T₄-5°C):20 to 40 s	
		Pre-reflow soldering: 1 time	
		(Initial measurements)	
		Reflow soldering: 3 times	
		T ₄	
		T ₂	
		$\begin{array}{c c} & & & \\ & & & \\ & & & \\ & & & \\ & & & \\ & & & \\ & & & \\ & & & \\ & & & \\ & & & \\ & & & \\ & & & \\ & & & \\ & & & \\ & & \\ & & & \\ & &$	
		Visual examination	No visible damage
	Component solvent		ΔR≤±1%
	resistance	Sub-clause 4.29	
		Solvent: 2-propanol	
		Solvent temperature: 23 °C±5 °C	
		Method 2	
		Recovery: 48 h	No visible domage
		Visual examination	No visible damage
		Resistance	ΔR≤±1%

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Table-5(3)

	T	1able_5(3)	D (
No	Test items	Condition of test (JIS C 5201–1)	Performance requirements
8	Mounting	Sub-clause 4.31	
		Substrate material: Epoxide woven glass	
	Adhesion	Sub-clause 4.32	
		Force: 5 N	
		Duration: 10 s±1 s	
		Visual examination	
	Rapid change temperature	Sub-clause 4.19	No visible damage
		Lower category temperature:	_
		_55 °C	
		Upper category temperature:	
		+155 °C	
		Duration of exposure at each temperature: 30	
		min.	
		Number of cycles: 5 cycles.	
		Visual examination	No visible damage
			ΔR≤±1%
9	Climatia aggueras	Resistance	
9	Climatic sequence	Sub-clause 4.23	
	-Dry heat	Sub-clause 4.23.2	
		Test temperature: +155 °C	
		Duration: 16 h	
	–Damp heat, cycle	Sub-clause 4.23.3	
	(12+12hour cycle)	Test method: 2	
	First cycle	Test temperature: 55 °C	
		[Severity(2)]	
	-Cold	Sub-clause 4.23.4	
		Test temperature –55 °C	
		Duration: 2h	
	-Damp heat, cycle	Sub-clause 4.23.6	
	(12+12hour cycle)	Test method: 2	
	Remaining cycle	Test temperature: 55 °C	
		[Severity (2)]	
		Number of cycles: 5 cycles	
	–D.C. load	Sub-clause 4.23.7	
		The applied current shall be the rated current.	
		Duration: 1 min.	
		Visual examination	No visible damage
		Resistance	ΔR ≤ ±5 %
10	Mounting	Sub-clause 4.31	
'	i woo iii ig	Substrate material: Epoxide woven glass	
	Endurance at 70 °C	Sub-clause 4.25.1	
		Ambient temperature: 70 °C±2 °C	
		Duration: 1000 h	
		The current shall be applied in cycles of 1.5 h	
		on and 0.5 h.	
		The applied current shall be the rated current	
		Examination at 48 h, 500 h and	
		1000 h:	No vicible damage
		Visual examination	No visible damage
		Resistance	ΔR≤±5%

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Table-5(4)

No	Test items	Condition of test (JIS C 5201–1)	Performance requirements		
11	Mounting	Sub-clause 4.31			
		Substrate material: Epoxide woven glass			
	Variation of resistance with	Sub-clause 4.8	As in Table–1		
	temperature	+20 °C / +155 °C			
12	Mounting	Sub-clause 4.31			
		Substrate material: Epoxide woven glass			
	Damp heat, steady state	Sub-clause 4.24			
		Ambient temperature: 40 °C±2 °C			
		Relative humidity: 93^{+2}_{-3} %			
		Without current applied.			
		Visual examination	No visible damage		
		B 1.	Legible marking		
40	D: (1.18)	Resistance	ΔR ≤ ±5%		
13	Dimensions (detail)	Sub-clause 4.4.3	As in Table-4		
	Mounting				
	Mounting	Sub-clause 4.31			
	Endurance at upper	Substrate material: Epoxide woven glass			
	Endurance at upper category temperature	Sub-clause 4.25.3			
	category temperature	Ambient temperature:155 °C±2 °C			
		Duration: 1000 h			
		Examination at 48 h, 500 h and 1000 h:			
		Visual examination	No visible damage		
		Resistance	$\Delta R \le \pm 5\%$		
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8. Taping

- 8.1 Applicable documents JIS C 0806-3: 2014, EIAJ ET-7200C: 2010
- 8.2 Taping dimensions
- 8.2.1 Paper taping (8mm width, 4mm pitches)

Taping dimensions shall be in accordance with Figure-3 and Table-6.

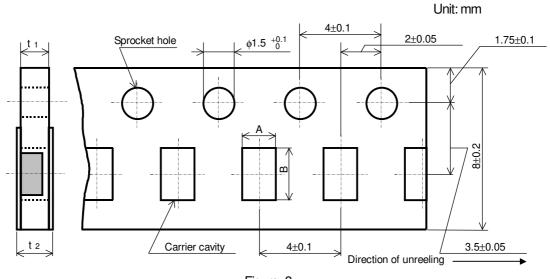


Figure-3							
	Unit: mm						
Style	Α	В	t 1	t 2			
TWLC32	2.00±0.15	3.6±0.2	0.8±0.1	1.0max.			

8.2.2 Embossed taping dimensions shall be in accordance with Figure-4 and Table-7.

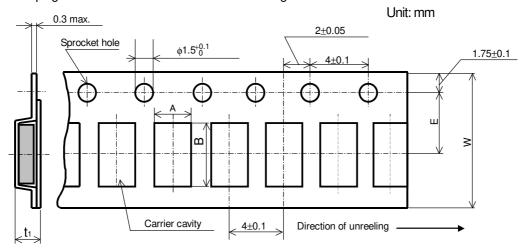


Figure-4 Table-7 Unit: mm В W Ε Α t₁ 3.1 ± 0.2 5.5 ± 0.2 12±0.3 5.5±0.05 1.1±0.15 3.6±0.2 6.9±0.2

Style

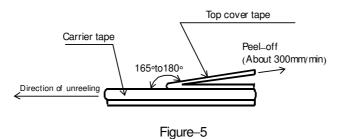
TWLC50

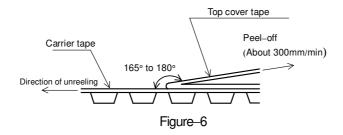
TWLC63

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- 1). The cover tapes shall not cover the sprocket holes.
- 2). Tapes in adjacent layers shall not stick together in the packing.
- 3). Components shall not stick to the carrier tape or to the cover tape.
- 4). Pitch tolerance over any 10 pitches ±0.2mm.
- 5). The peel strength of the top cover tape shall be with in 0.1N to 0.5N on the test method as shown in the following TWLC32: Figure–5, TWLC50,63: Figure–6.
- 6). When the tape is bent with the minimum radius for (TWLC32: 25mm, TWLC50,63: 30mm) the tape shall maintain their position and orientation in the tape.
- 7). In no case shall there be two or more consecutive components missing.

 The maximum number of missing components shall be one or 0.1%, whichever is greater.
- 8). The resistors shall be faced to upward at the over coating side in the carrier cavity.

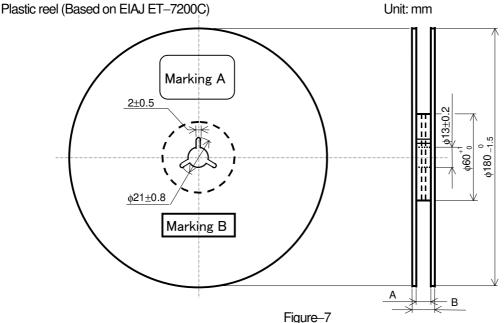




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8.3 Reel dimension

Reel dimensions shall be in accordance with the following Figure-7 and Table-8.



 Table—8
 Unit: mm

 A
 B
 Note

 9 +1.0 0
 11.4±1.0 Injection molding

 13+1.0 Vacuum forming

Note: Marking label shall be marked on a place of Marking A or two place of marking A and B.

8.4 Leader and trailer tape.

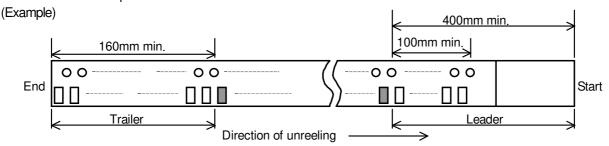


Figure-8

9. Marking on package

The label of a minimum package shall be legibly marked with follows.

Style

9.1 Marking A

(1) Classification

(Style, Temperature coefficient of resistance, Rated resistance, Tolerance on rated resistance, Packaging form)

(2) Quantity (3) Lot number (4) Manufacturer's name or trade mark (5) Others

9.2 Marking B (KAMAYA control label)

单击下面可查看定价,库存,交付和生命周期等信息

>>Kamaya(釜屋电机)